

# DATA SHEET for LED

Part No.	LH30640		
Emitted Color	Lens Color		Chip Material
Red	Color Diffused		GaAsP/GaP

## Absolute Maximum Rating of Each Segment ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Maximum Rating	Unit
Power Dissipation	$P_M$	80	mW
Pulse Forward Current (Duty 1/10 @ 1kHz)	$I_{FP}$	100	mA
Continuous Forward Current	$I_F$	30	mA
Reverse Voltage	$V_R$	6	V
Operation Temperature	$T_{opr}$	$-25^\circ\text{C} \sim 85^\circ\text{C}$	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	$-40^\circ\text{C} \sim 100^\circ\text{C}$	$^\circ\text{C}$
Soldering Temperature : 2.0mm from Body for 3 seconds at $260^\circ\text{C}$			

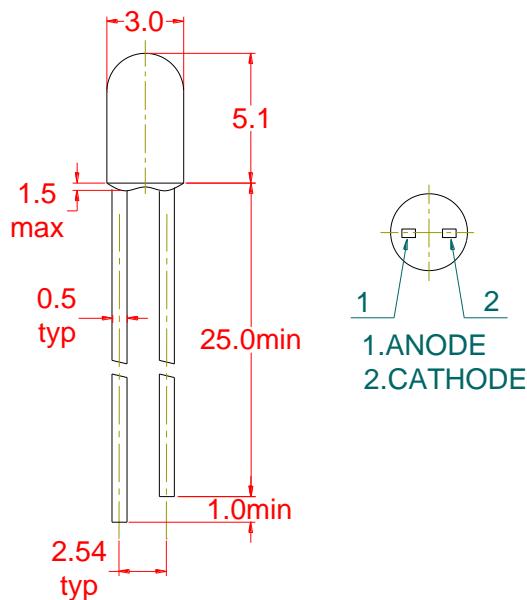
## Electron-Optical Characteristics of Each Segment ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	$I_V$		3		mcd	$I_F=20 \text{ mA}$
Forward Voltage	$V_F$		2.2	2.5	V	$I_F=20 \text{ mA}$
Reverse Current	$I_R$			20	$\mu\text{A}$	$V_R=5\text{V}$
Dominant Wavelength	$\lambda_d$		660		nm	$I_F=20 \text{ mA}$
Peak Emission Wavelength	$\lambda_p$		697		nm	$I_F=20 \text{ mA}$
Spectral Line Half Width	$\Delta\lambda$		26		nm	$I_F=20 \text{ mA}$
Viewing Angle	$2\theta_{1/2}$		43		deg	$I_F=20 \text{ mA}$

Note :

- 1) The luminous intensity data and  $\lambda_p$  is survey values with the machine JF-II, JS-2000.
- 2)  $2\theta_{1/2}$  is the chip angle at which the luminous intensity half the axial luminous intensity.

**Package Dimensions :** 3mm Round without Flangeless resin mold type



Note : 1) All dimensions are in millimeters(mm)

2) Tolerance is  $\pm 0.25\text{mm}$  unless otherwise note

#### Typical Characteristic Curves :

